

General Description

The MAX4112/MAX4113 current-mode feedback amplifiers combine high-speed performance with low-power operation. The MAX4112 is optimized for closed-loop gains of 2V/V or greater, while the MAX4113 is optimized for gains of 8V/V or greater.

The MAX4112/MAX4113 require only 5mA of supply current and deliver bandwidths of 500MHz (Ay ≥ 2V/V) and 275MHz (A_V ≥ 8V/V), respectively. The high slew rates (1200V/µs and 1800V/µs) provide exceptional fullpower bandwidths (300MHz and 250MHz), making these amplifiers ideal for high-performance pulse and RGB video applications.

These high-speed op amps have a wide output voltage swing of $\pm 3.5 \text{V}$ into 100Ω and a high current-drive capability of 80mA.

Applications

Broadcast and High-Definition TV Systems

RGB Video

Pulse/RF Amplifier

Ultrasound

Active Filters

ADC Buffers

Features

- ♦ 500MHz -3dB Bandwidth (MAX4112) 275MHz -3dB Bandwidth (MAX4113)
- ♦ 0.1dB Gain Flatness to 30MHz (MAX4112)
- † 1200V/µs Slew Rate (MAX4112) 1800V/µs Slew Rate (MAX4113)
- **♦ 300MHz Full-Power Bandwidth** $(V_O = 2V_{P-p}, MAX4112)$ 250MHz Full-Power Bandwidth $(V_0 = 2V_{p-p}, MAX4113)$
- ♦ High Output Drive: 80mA
- **♦ Low Power: 5mA Supply Current**

Ordering Information

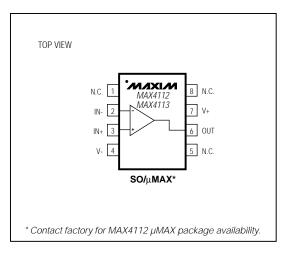
PART	TEMP. RANGE	PIN-PACKAGE
MAX4112ESA	-40°C to +85°C	8 SO
MAX4112EUA	-40°C to +85°C	8 μMAX*
MAX4113ESA	-40°C to +85°C	8 SO

^{*} Contact factory for µMAX package availability.

Typical Application Circuit

R_G 499Ω 75**Ω** 75**Ω** CABLE 75Ω CABLE VIDEO VIDEO 1000pF VIDEO LINE DRIVER

Pin Configuration



/VIXI/VI

Maxim Integrated Products 1

Call toll free 1-800-998-8800 for free samples or literature.

ABSOLUTE MAXIMUM RATINGS

Power Supply Voltage (V _{CC} to V _{EE})Voltage on Any Pin to Ground or Any Other Pin	
Short-Circuit Duration (Vout to GND)	
V _{IN} < 1.5V	Continuous
V _{IN} > 1.5V	0sec
Continuous Power Dissipation ($T_A = +70$ °C)	
SO (derate 5.88mW/C above +70°C)	471mW
μMAX (derate 4.10mW/C above +70°C)	330mW

Operating Temperature Range	
MAX4112E_A/MAX4113E_A40°C to +85°	,C
Storage Temperature Range65°C to +160°	,C
Lead Temperature (soldering, 10sec)+300°	,C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = 5V, V_{EE} = -5V, T_A = T_{MIN} to T_{MAX} , typical values are at T_{A} = +25°C, unless otherwise noted.)

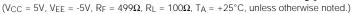
PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DC SPECIFICATIONS		1					1
Input Offset Voltage	Vos	Vout = 0V			1	8	mV
Input Offset Voltage Drift	TCVos	V _{OUT} = 0V			10		μV/°C
Positive Input Bias Current	I _{B+}	Vout = 0V, VIN = -Vo	S		3.5	20	μΑ
Negative Input Bias Current	I _B -	Vout = 0V, VIN = -Vo	S		3.5	20	μΑ
Innut Decistores		IN+			500		kΩ
Input Resistance		IN-			30		Ω
Input Capacitance		IN+	IN+		2		pF
Input Voltage Noise	en	f = 10kHz			2.2		nV/√Hz
Integrated Voltage Noise	EnRMS	f = 1MHz to 100MHz			27		μVRMS
Positive Input Current Noise	i _{n+}	f = 10kHz	MAX4112		13	D A /a/E	pA/√Hz
			MAX4113		9		PAVITZ
Negative Input Current Noise	i _{n-}	f = 10kHz			14		pA/√Hz
Common-Mode Input Voltage	VcM			-2.5		2.5	V
Common-Mode Rejection	CMR	V _{CM} = ±2.5V		45	50		dB
Power-Supply Rejection	PSR	$V_S = \pm 4.5 V \text{ to } \pm 5.5 V$		60	80		dB
Open-Loop Transimpedance	ZOL	$V_{OUT} = \pm 2.0V$, $V_{CM} = 0V$, $R_L = 100\Omega$		250	500		kΩ
Quiescent Supply Current	I _{SY}	V _{IN} = 0V			5	6.5	mA
Output Voltage Suring	\/a=	R _L = ∞		±3.5	±3.8		V
Output Voltage Swing	Vout	R _L = 100Ω		±3.1	±3.5		V
Output Current Drive	lout	$R_L = 30\Omega$, $T_A = 0^{\circ}C$ to $+85^{\circ}C$		65	80		mA

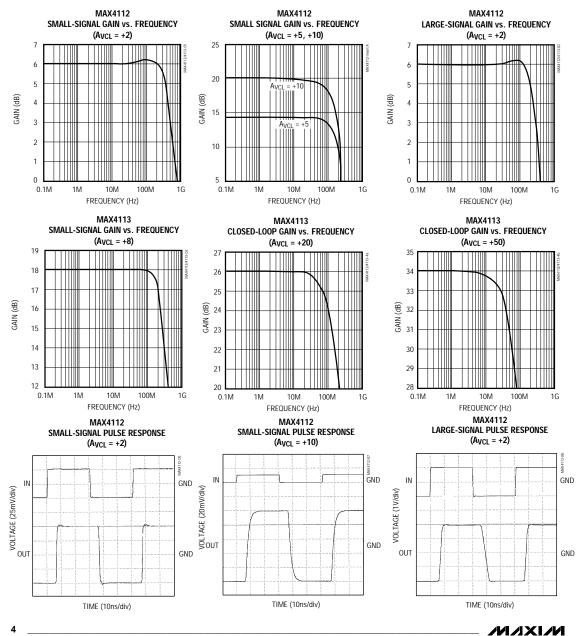
ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = 5V, V_{EE} = -5V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ typical values are at } T_A = +25^{\circ}C, \text{ unless otherwise noted.})$

PARAMETER	SYMBOL	CONDITIONS		MIN TYP	MAX	UNITS	
AC SPECIFICATIONS							
2-10 0	DW	V	MAX4112	500		MHz	
-3dB Bandwidth	BW-3dB	Vout ≤ 0.1V _{RMS}	MAX4113	275			
0.1dB Bandwidth	514	MAX4112, Avcl = +2		30		MHz	
U. TOB BAHOWIGHT	BW _{0.1dB}	MAX4113, Avcl = +8		90	IVIHZ		
Full-Power Bandwidth	FPBW	Vo = 2Vp-p	MAX4112	300		MHz	
ruii-Powei Balluwiuiii	FFDW	ν() = 2νρ-ρ	MAX4113	250			
Slew Rate	SR	-2V ≤ VOUT ≤ 2V	MAX4112	1200		V/µs	
Siew Rate	JK.	-2V \(\sum_{001} \)\(\sum_{2V} \)	MAX4113	1800			
		to 0.1%, -1V ≤ V _{OUT} ≤ 1V	MAX4112	15		ns	
Settling Time	ts	$R_L = 100\Omega$	MAX4113	10			
		to 0.01%, -1V ≤ V _{OUT} ≤ 1	V, MAX4112	35			
		$R_L = 100\Omega$	MAX4113	25			
10% to 90%, -2V ≤ V _{OUT} ≤ 2V, R _L =		≤ 2V, R _L = 100Ω	3				
Rise/Fall Times	t _R , t _F	10% to 90%, -50mV \leq V _{OUT} \leq 50mV, R _L = 100 Ω		0.8		- ns	
Differential Gain	DG	f = 3.58MHz	MAX4112, Avcl = +2	0.02		%	
Differential Gain DG 1 = 3.58MF		1 = 3.00IVITZ	= 3.58IVIH2 MAX4113, A _{VCL} = +8		0.02		
Differential Phase	DP	f = 3.58MHz	MAX4112, Avcl = +2	0.03		degrees	
Differential Priase	DP	1 = 3.50IVITZ	MAX4113, A _{VCL} = +8	0.04			
Input Capacitance	CIN	·				pF	
Output Impedance	Zout	f = 10MHz, A _{VCL} = +2		0.9		Ω	
Spurious-Free	SFDR	1.0 0	MAX4112, A _{VCL} = +2	-68		dBc	
Dynamic Range	JI DR	Vout = 2Vp-p	MAX4113, A _{VCL} = +8	-62] ubc	
Two-Tone Third-Order Intercept	IP3	f _C = 10MHz, A _{VCL} = +2		36		dB	

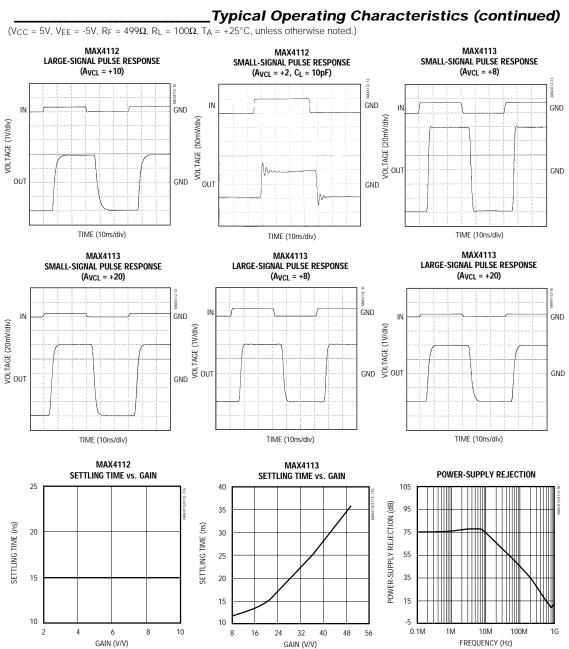
Typical Operating Characteristics





MAX4112/MAX4113

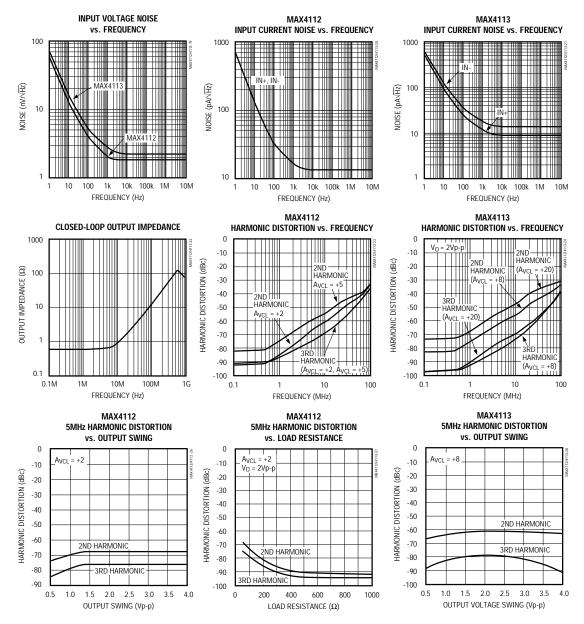
500MHz, Low-Power, Current-Mode Feedback Amplifiers



_Typical Operating Characteristics (continued)

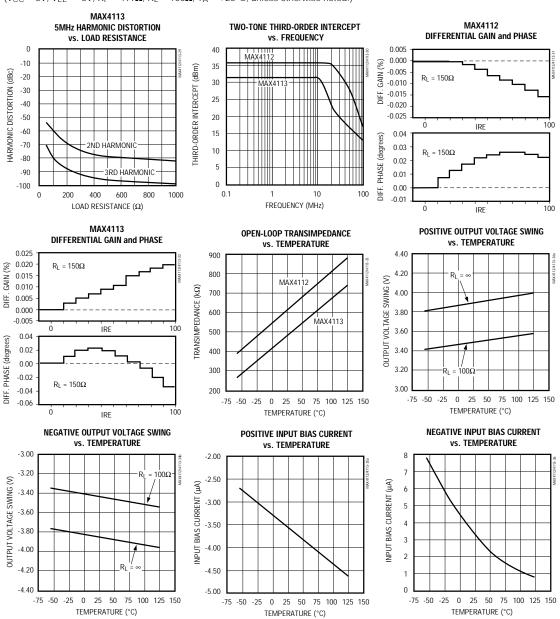
MIXIM

 $(V_{CC}=5V,\,V_{EE}=-5V,\,R_F=499\Omega,\,R_L=100\Omega,\,T_A=+25^{\circ}C,\,unless$ otherwise noted.)



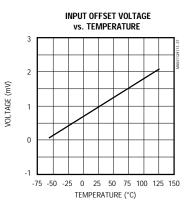
_Typical Operating Characteristics (continued)

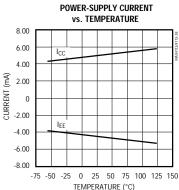
 $(V_{CC} = 5V, V_{EE} = -5V, R_F = 499\Omega, R_L = 100\Omega, T_A = +25^{\circ}C$, unless otherwise noted.)

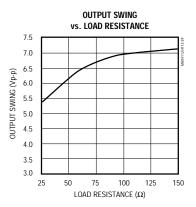


Typical Operating Characteristics (continued)

 $(V_{CC} = 5V, V_{EE} = -5V, R_F = 499\Omega, R_L = 100\Omega, T_A = +25^{\circ}C$, unless otherwise noted.)







_Pin Description

PIN	NAME	FUNCTION		
1, 5, 8	N.C.	No Connection, not internally connected		
2	IN-	Inverting Input		
3	IN+	Noninverting Input		
4	V _{EE}	Negative Power Supply, connect to -5V		
6	OUT	Amplifier Output		
7	Vcc	Positive Power Supply, connect to +5V		

Detailed Description

The MAX4112 is optimized for closed-loop gains (AyCI) of 2V/V or greater, while the MAX4113 is optimized for closed-loop gains of 8V/V or greater. These low-power, high-speed current-mode feedback amplifiers operate from ±5V supplies. They are designed to drive video loads with excellent distortion characteristics. The MAX4112's differential gain and phase are 0.02% and 0.03°, respectively; the MAX4113 exhibits gain/phase error specifications of 0.02% and 0.04°, respectively. These characteristics, plus a wide 0.1dB bandwidth, make the MAX4112/MAX4113 ideal for use in broadcast and graphics video systems. The combination of ultra-high speed and low power makes these parts ideal for use in general-purpose high-speed applications, such as medical imaging, industrial instrumentation, and communications systems.

_Applications Information

Theory of Operation

Since the MAX4112/MAX4113 are current-feedback amplifiers, their open-loop transfer function is expressed as a transimpedance, ΔV_{OUT}/ΔI_{IN}, or Z_{OL}. The frequency behavior of the open-loop transimpedance is similar to the open-loop gain of a voltage-mode feedback amplifier. That is, it has a large DC value and decreases at approximately 6dB/octave.

Analyzing the follower with gain, as shown in Figure 1, yields the following transfer function:

$$\frac{V_{OUT}}{V_{IN}} \ = \ G \ x \ \frac{Z_{OL(S)}}{Z_{OL(S)} \ + \ G \ x \ R_{IN} \ + \ R_F}$$

where G = A_{VCL} = 1 + R_F / R_G, and R_{IN} = $1/g_M \cong 30\Omega$.

At low gains, G x R_{IN} << R_F . Therefore, the closed-loop bandwidth is essentially independent of closed-loop gain. Similarly Z_{OL} >> R_F at low frequencies, so that:

$$\frac{V_{OUT}}{V_{IN}} = G = 1 + R_F/R_G$$

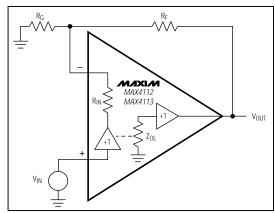


Figure 1. Current Feedback Amplifier

Layout and Power-Supply Bypassing

The MAX4112/MAX4113 have an RF bandwidth and, consequently, require careful board layout, including the possible use of constant-impedance Microstrip or Stripline techniques.

To realize the full AC performance of these high-speed amplifiers, pay careful attention to power-supply bypassing and board layout. The PC board should have at least two layers: a signal and power layer on one side, and a large, low-impedance ground plane on the other side. The ground plane should be as free of voids as possible. With multilayer boards, locate the ground plane on a layer that incorporates no signal or power traces.

Regardless of whether a constant-impedance board is used, it is best to observe the following guidelines when designing the board. Wire-wrap boards are much too inductive, and breadboards are much too capacitive; neither should be used. IC sockets increase para-

sitic capacitance and inductance, and should not be used. In general, surface-mount components give better high-frequency performance than through-hole components. They have shorter leads and lower parasitic reactances. Keep lines as short and as straight as possible. Do not make 90° turns; round all corners.

Observe high-frequency bypassing techniques to maintain the amplifier's accuracy. The bypass capacitors should include a 1000pF ceramic capacitor between each supply pin and the ground plane, located as close to the package as possible. Next, place a 0.01µF to 0.1µF ceramic capacitor in parallel with each 1000pF capacitor, and as close to them as possible. Then place a 10µF to 15µF low-ESR tantalum at the point of entry (to the PC board) of the power-supply pins. The power-supply trace should lead directly from the tantalum capacitor to the V_{CC} and V_{EE} pins. To minimize parasitic inductance, keep PC traces short and use surface-mount components.

Choosing Feedback and Gain Resistors

The MAX4112/MAX4113 are current-feedback amplifiers optimized for a 499 Ω feedback resistor. Although a standard 5% value is sufficient, a 1% value is preferred to maintain consistency over a wide range of production lots. Changing feedback resistor value will reduce the bandwidth or cause excessive peaking. To change the magnitude of the gain, use the input resistor (R_F). Figure 2 shows the standard inverting and noninverting configurations. Notice that the gain of the noninverting circuit (Figure 2a) is 1 plus the magnitude of the inverting closed-loop gain. Otherwise the two circuits are identical and equivalent (see Table 1).

DC and Noise Errors

There are several major error sources to consider in any operational amplifier. These apply equally to the MAX4112/MAX4113. Offset-error terms are given by the equation below. Voltage and current noise errors are

Table 1. Recommended Component Values

COMPONENT	MAX4112			MAX4113					
	-2	+2	+10	+25	-8	+8	+10	+50	+100
$R_F\left(\Omega\right)$	499	499	499	499	499	499	499	499	499
R _G (Ω)	247	499	56	20	62.5	69	56	10	5
$R_O\left(\Omega\right)$	49.9	49.9	49.9	49.9	49.9	49.9	49.9	49.9	49.9
R _S (Ω)	0	_	_	_	_	0	_	_	_
$R_T \; (\Omega)$	62.5	49.9	49.9	49.9	250	49.9	49.9	49.9	49.9
Small-Signal Bandwidth (MHz)	180	500	100	50	325	275	235	50	23
0.1dB Flatness (MHz)	40	30	15	8	90	90	79	8	4

root-square summed and, therefore, computed separately. In Figure 3, the total output offset voltage is determined by:

- a) The input offset voltage (Vos) times the closed-loop gain (1 + RF / RG)
- b) The positive input bias current (I_{B+}) times the source resistor (R_S) (usually 50Ω or 75Ω), plus the negative input bias current (I_{B-}), times the parallel combination of R_G and R_F . In current-mode feedback amplifiers, the input bias currents may flow into or out of the device; for this reason, there is no benefit to matching the resistance at both inputs.

The equation for total DC error is:

$$V_{OUT} = [(I_{B+})R_S + (I_{B-})(R_F || R_G) + V_{OS}] (1\frac{R_F}{R_G})$$

c) The total output referred noise voltage is:

$$e_{n(OUT)} = \left(1 + \frac{R_F}{R_G}\right) \sqrt{\left[\left(i_{n+}\right)R_S\right]^2 + \left[\left(i_{n-}\right)R_F \mid\mid R_G\right]^2 + \left(e_n\right)^2}$$

The MAX4112 has a very low, $2nV/\sqrt{Hz}$ noise voltage. The current noise at the positive input (in+) is $13pA/\sqrt{Hz}$, and the current noise at the inverting input is $14pA/\sqrt{Hz}$.

An example of the DC error calculations, using the MAX4112 typical data and the typical operating circuit using R_F = R_G =500 Ω (R_F | R_G = 250 Ω) and R_S = 50 Ω gives:

$$V_{OUT} = (3.5 \times 10^{-6} \times 50 + 3.5 \times 10^{-6} \times 250 + 10^{-3}) (1 + 1)$$

 $V_{OUT} = 4.1 \text{mV}$

Calculating total output noise in a similar manner yields:

$$\begin{split} &e_{n(OUT)} = (1+1)\sqrt{\left(13x10^{-12}\,x50\right)^2 + \left(14x10^{-12}\,x250\right)^2 + \left(2x10^{-9}\right)^2} \\ &e_{n(OUT)} = & 4nV/\sqrt{Hz} \end{split}$$

With a 200MHz system bandwidth, this calculates to $56.6\mu V_{RMS}$ (approximately $340\mu Vp$ -p, choosing the six-sigma value).

Resistor Types

Surface-mount resistors are the best choice for high-frequency circuits. They are of similar material to metal-film resistors, but are deposited using a thick-film process in a flat, linear manner that minimizes inductance. Their small size and lack of leads also minimizes parasitic inductance and capacitance, yielding more predictable performance.

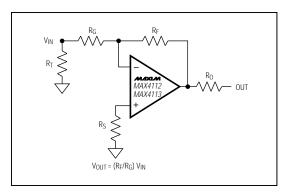


Figure 2a. Inverting Gain Configuration

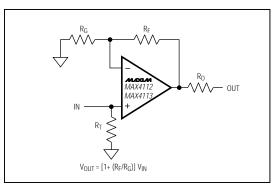


Figure 2b. Noninverting Gain Configuration

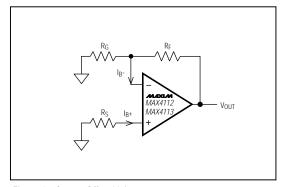


Figure 3. Output Offset Voltage

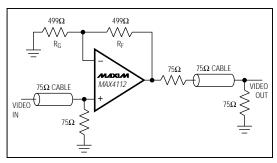


Figure 4. Video Line Driver

Metal-film resistors with leads are manufactured using a thin-film process where resistive material is deposited in a spiral layer around a ceramic rod. Although the materials used are noninductive, the spiral winding presents a small inductance (about 5nH) that may have an adverse effect on high-frequency circuits.

Carbon composition resistors with leads are manufactured by pouring the resistor material into a mold. This process yields relatively low-inductance resistors that are very useful in high-frequency applications, although they tend to cost more and have more thermal noise than other types. The ability of carbon composition resistors to self-heal after a large current overload makes them useful in high-power RF applications.

For general-purpose use, surface-mount metal-film resistors seem to have the best overall performance for low cost, low inductance, and low noise.

Video Line Driver

The MAX4112/MAX4113 are optimized (gain flatness) to drive coaxial transmission lines when the cable is terminated at both ends, as shown in Figure 4. Cable frequency response may cause variations in the flatness of the signal.

Driving Capacitive Loads

The MAX4112/MAX4113 are optimized for AC performance. They are not designed to drive highly capacitive loads. Reactive loads will decrease phase margin and may produce excessive ringing and oscillation. Figure 5 shows a circuit that eliminates this problem. The small (usually 5Ω to 20Ω) isolation resistor, R_S, placed before the reactive load will prevent ringing and oscillation. At higher capacitive loads, AC performance will be controlled by the interaction of the load capacitance and isolation resistor.

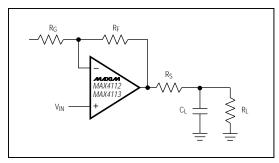


Figure 5a. Using an Isolation Resistor (Rs) for High Capacitive Loads

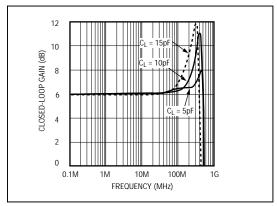


Figure 5b. Frequency Response vs. Capacitive Load—No Isolation Resistor

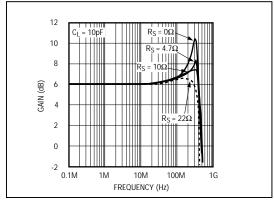
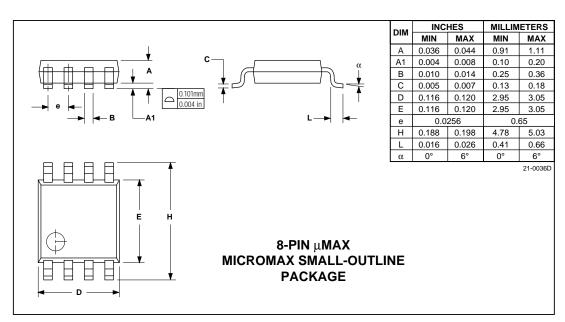


Figure 5c. Frequency Response vs. Isolation Resistance (see Figure 5a for circuit)

	_Chip	Information
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TRANSISTOR COUNT: 53

Package Information



Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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